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Renesas Electronics Corporation

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# SH7000 Series

## Quotient of 32 Bit ÷ 32 Bit (Unsigned)

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**Label:** DIVU32Q

**Functions Used:** DIV0U Instruction  
DIV1 Instruction

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## 1. Function

Divides the dividend (unsigned 32 bits) by the divisor (unsigned 32 bits), and determines the quotient (unsigned 32 bits). Also indicates errors (division by 0) in the T bit.

## 2. Arguments

Description		Storage Location	Data Length (Bytes)
Input	Dividend (unsigned 32 bits)	R1	4
	Divisor (unsigned 32 bits)	R0	4
Output	Quotient (unsigned 32 bits)	R1	4
	Error (division by 0) generated/not generated (generated: T = 1, not generated: T = 0)	T bit (SR)	4

**3. Internal Register Changes and Flag Changes**

(Before Execution) → (After Execution)

R0	Divisor (unsigned 32 bits) → No change
R1	Dividend (unsigned 32 bits) → Quotient (unsigned 32 bits)
R2	Work
R3	
R4	
R5	
R6	
R7	
R8	
R9	
R10	
R11	
R12	
R13	
R14	
R15	(SP)

- T bit \* — : No change  
 \* : Change  
 0 : Fixed 0  
 1 : Fixed 1

#### 4. Programming Specifications

Program memory (bytes)
152
Data memory (bytes)
0
Stack (bytes)
4
Number of states
74
Reentrant
Yes
Relocation
Yes
Intermediate interrupt
Yes

#### 5. Notes

The number of states indicated in the programming specifications is the value when  $H'FFFFFFF \div H'FFFFFFE$  is calculated.

## 6. Description

### (1) Function

Details of the arguments are as follows.

R0: Set the divisor (unsigned 32 bits) as the input argument.

R1: Set the dividend (unsigned 32 bits) as the input argument.  
Holds the quotient (unsigned 32 bits) as the output argument.

T bit (SR): Indicates whether an error (division by 0) has occurred.  
T bit = 1: Indicates an error (division by 0) has occurred.  
T bit = 0: Indicates no error (division by 0) has occurred.

Figure 1 shows a software DIVU32Q execution example.

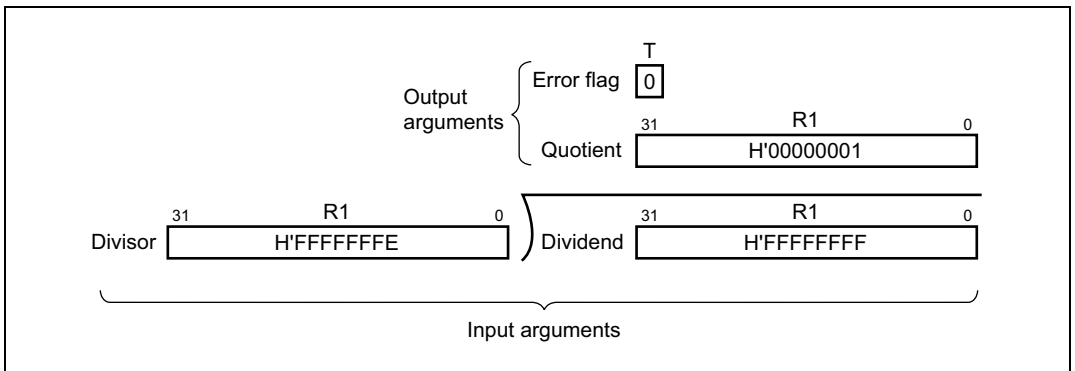


Figure 1 Software DIVU32Q Execution Example

### (2) Usage Notes

After execution of software instruction DIVU32Q, the quotient is set in R1, which previously contained the dividend, and the dividend is destroyed. If the value for the dividend will be needed after the software DIVU32Q instruction is executed, it should be saved beforehand.

### (3) RAM Used

No RAM is used by the software DIVU32Q instruction.

### (4) Usage Example

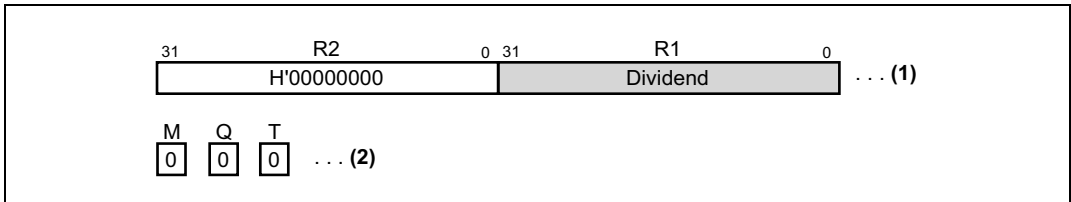
After the dividend and divisor are set in the input arguments, the software instruction DIVU32Q is executed by a subroutine call.

```

MOV.L DATA1,R1    . . . . Sets dividend (unsigned 32 bits) in input argument (R1)
BSR   DIVU32Q      . . . . Subroutine call to software instruction DIVU32Q
MOV.L DATA2,R0    . . . . Sets divisor (unsigned 32 bits) in input argument (R0)
BT    ERROR        . . . . Branches to error processing subroutine if error (division by 0) occurs
    .
    .
    .
.align 4
DATA1 .data.l H'FFFFFFFF
DATA2 .data.l H'FFFFFFFE
    
```

### (5) Operating Principle

- (a) Before division, the following initial settings are carried out.
  - (i) R2 is used for the upper 32 bits to zero-extend the dividend to 64 bits.  
(Figure 2-(1))
  - (ii) The M, Q, and T bits used in one-step division are set to division values.  
(Figure 2-(2))



**Figure 2 Initial Settings**



(b) As shown in figure 3, the division operation is repeated through the number of divisor bits (32 times) using the ROCTL and DIV1 instructions.

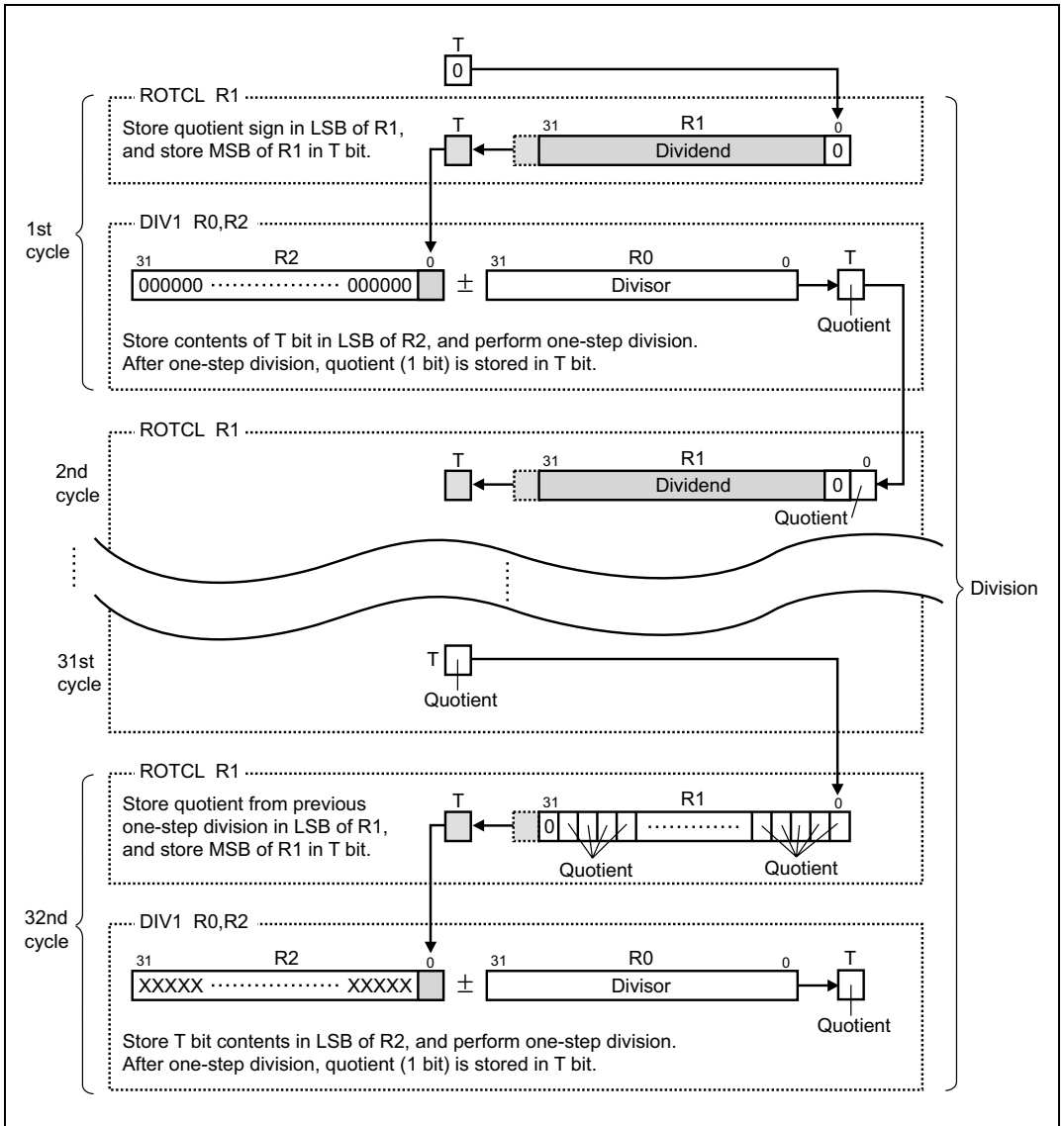


Figure 3 Division

- (c) As shown in figure 4, the 32nd quotient of one-step division is stored in the T bit at the end of division. The 32nd quotient of one-step division stored in the T bit is stored in the LSB of R1, and the R1 contents are the final quotient.

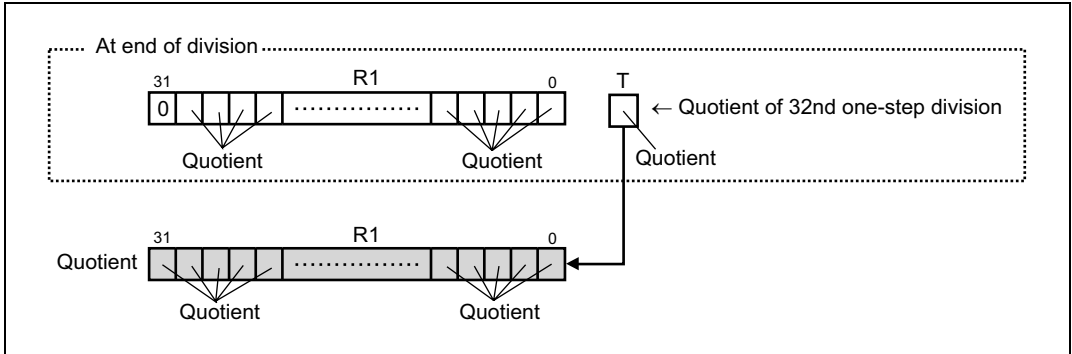
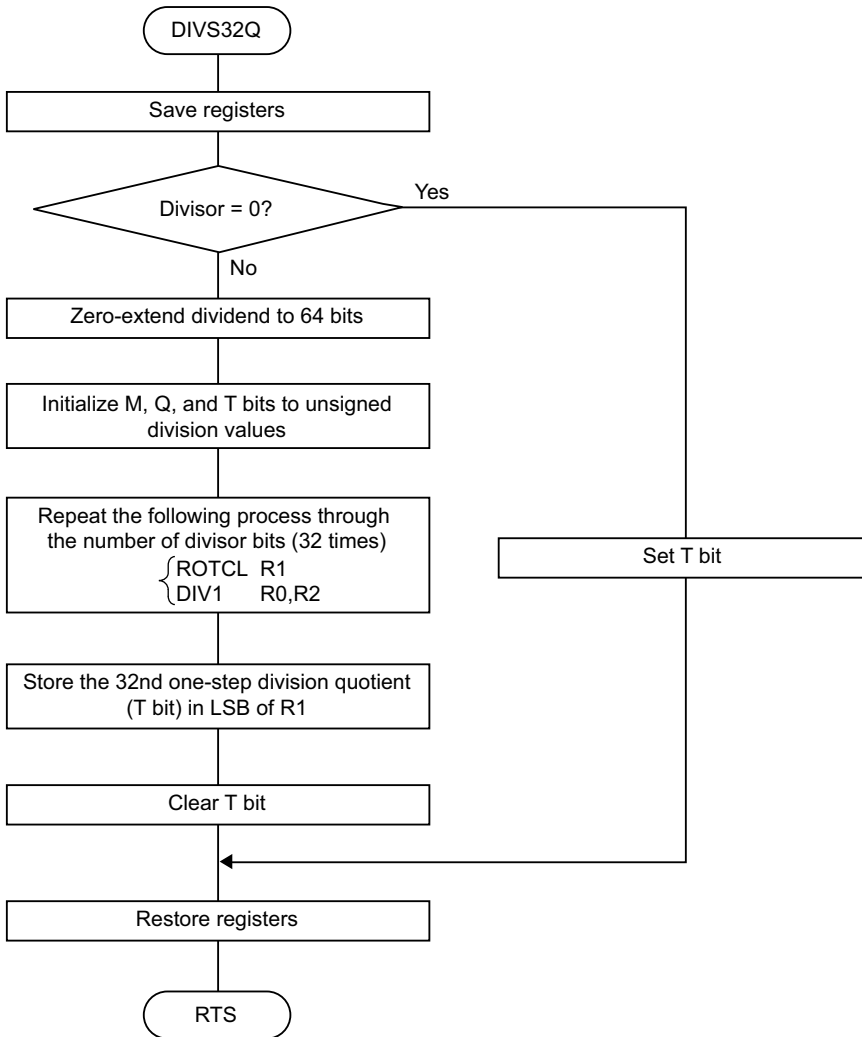


Figure 4 Quotient

7. Flowchart



## 8. Program Listing

```

1          1      ;*****
2          2      ;*
3          3      ;*      NAME ; QUOTIENT OF 32 BIT UNSIGNED DIVISION (DIVU32Q) *
4          4      ;*
5          5      ;*****
6          6      ;*
7          7      ;*      ENTRY : R1 (DIVIDEND)
8          8      ;*      R0 (DIVISOR)
9          9      ;*      RETURNS : R1 (QUOTIENT)
10         10     ;*      T BIT (ERROR -> TRUE;T=1,FALSE;T=0
11         11     ;*
12         12     ;*****
13 00001000 13         .SECTION A, CODE, LOCATE=H'1000
14         14     DIVU32Q .EQU $ ; Entry point
15 00001000 2F26 15     MOV.L R2,@-R15 ; Escape register
16 00001002 2008 16     TST R0,R0 ; Divisor = 0 ?
17 00001004 8945 17     BT DIVU32Q1 ; Yes
18 00001006 222A 18     XOR R2,R2 ; R2 <- H'00000000
19 00001000 0019 19     DIV0U ; Divide as unsigned
20         20     ;
21 0000100A 4124 21     ROTCL R1 ; Divide 1 step
22 0000100C 3204 22     DIV1 R0,R2 ;
23 0000100E 4124 23     ROTCL R1 ;
24 00001010 3204 24     DIV1 R0,R2 ;
25 00001012 4124 25     ROTCL R1 ;
26 00001014 3204 26     DIV1 R0,R2 ;
27 00001016 4124 27     ROTCL R1 ;
28 00001018 3204 28     DIV1 R0,R2 ;
29 0000101A 4124 29     ROTCL R1 ;
30 0000101C 3204 30     DIV1 R0,R2 ;
31 0000101B 4124 31     ROTCL R1 ;
32 00001020 3204 32     DIV1 R0,R2 ;
33 00001022 4124 33     ROTCL R1 ;
34 00001024 3204 34     DIV1 R0,R2 ;
35 00001026 4124 35     ROTCL R1 ;
36 00001028 3204 36     DIV1 R0,R2 ;
37         37     ;
38 0000102A 4124 38     ROTCL R1 ;
39 0000102C 3204 39     DIV1 R0,R2 ;
40 0000102E 4124 40     ROTCL R1 ;
41 00001030 3204 41     DIV1 R0,R2 ;
42 00001032 4124 42     ROTCL R1 ;
43 00001034 3204 43     DIV1 R0,R2 ;
44 00001036 4124 44     ROTCL R1 ;
45 00001038 3204 45     DIV1 R0,R2 ;
46 0000103A 4124 46     ROTCL R1 ;
47 0000103C 3204 47     DIV1 R0,R2 ;
48 0000103E 4124 48     ROTCL R1 ;
49 00001040 3204 49     DIV1 R0,R2 ;

```

```

50 00001042 4124      50      ROTCL  R1      ;
51 00001044 3204      51      DIV1   R0,R2   ;
52 00001046 4124      52      ROTCL  R1      ;
53 00001048 3204      53      DIV1   R0,R2   ;
54                    54                    ;
55 0000104A 4124      55      ROTCL  R1      ;
56 0000104C 3204      56      DIV1   R0,R2   ;
57 0000104E 4124      57      ROTCL  R1      ;
58 00001050 3204      58      DIV1   R0,R2   ;
59 00001052 4124      59      ROTCL  R1      ;
60 00001054 3204      60      DIV1   R0,R2   ;
61 00001056 4124      61      ROTCL  R1      ;
62 00001058 3204      62      DIV1   R0,R2   ;
63 0000105A 4124      63      ROTCL  R1      ;
64 0000105C 3204      64      DIV1   R0,R2   ;
65 0000105E 4124      65      ROTCL  R1      ;
66 00001060 3204      66      DIV1   R0,R2   ;
67 00001062 4124      67      ROTCL  R1      ;
68 00001064 3204      68      DIV1   R0,R2   ;
69 00001066 4124      69      ROTCL  R1      ;
70 00001068 3204      70      DIV1   R0,R2   ;
71                    71                    ;
72 0000106A 4124      72      ROTCL  R1      ;
73 0000106C 3204      73      DIV1   R0,R2   ;
74 0000106E 4124      74      ROTCL  R1      ;
75 00001070 3204      75      DIV1   R0,R2   ;
76 00001072 4124      76      ROTCL  R1      ;
77 00001074 3204      77      DIV1   R0,R2   ;
78 00001076 4124      78      ROTCL  R1      ;
79 00001078 3204      79      DIV1   R0,R2   ;
80 0000107A 4124      80      ROTCL  R1      ;
81 0000107C 3204      81      DIV1   R0,R2   ;
82 0000107E 4124      82      ROTCL  R1      ;
83 00001080 3204      83      DIV1   R0,R2   ;
84 00001082 4124      84      ROTCL  R1      ;
85 00001084 3204      85      DIV1   R0,R2   ;
86 00001086 4124      86      ROTCL  R1      ;
87 00001088 3204      87      DIV1   R0,R2   ;
88                    88                    ;
89 0000108A 4124      89      ROTCL  R1      ;
90 0000108C 0008      90      CLRT                ; T bit <- No error
91 0000108E 000B      91      RTS                ;
92 00001090 62F6      92      MOV.L   @R15+,R2   ; Return register
93 00001092          93      DIVU32Q1          ;
94 00001092 0018      94      SETT                ; T bit <- Error
95 00001094 000B      95      RTS                ;
96 00001096 62F6      96      MOV.L   @R15+,R2   ; Return register
97                    97      .END

*****TOTAL ERRORS      0
*****TOTAL WARNINGS    0

```

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